



**烜芯微**  
XUANXINWEI

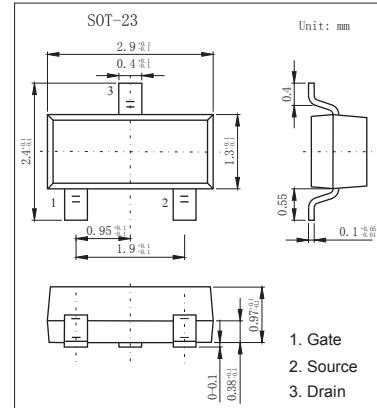
SMD Type

MOSFET

## P-Channel Enhancement MOSFET IRLML6402

### ■ Features

- Ultra low on-resistance.
- P-Channel MOSFET.
- SOT-23 Footprint.
- Low profile(<1.1mm).
- Available in tape and reel.
- Fast switching.



### ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	
Continuous Drain Current V <sub>GS</sub> =4.5V @ TA=25°C	I <sub>D</sub>	-3.7	A
Continuous Drain Current V <sub>GS</sub> =4.5V@ TA=70°C		-2.2	
Pulsed Drain Current a	I <sub>DM</sub>	-30	
Power Dissipation @ TA=25°C	P <sub>D</sub>	1.3	W
Power Dissipation @ TA=70°C		0.8	
Single Pulse Avalanche Energy b	E <sub>AS</sub>	11	mJ
Thermal Resistance.Junction- to-Ambient	R <sub>thJA</sub>	100	°C/W
Linear Derating Factor		0.01	W/°C
Junction Temperature	T <sub>J</sub>	150	°C
Junction and Storage Temperature Range	T <sub>stg</sub>	-55 to 150	

Notes:

a.Repetitive Rating :Pulse width limited by maximum junction temperature

b.Starting TJ=25°C, L=1.65mH, R<sub>G</sub>=25Ω, I<sub>AS</sub>=-3.7A



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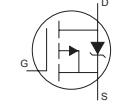
## P-Channel Enhancement MOSFET IRML6402

### ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-source Breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0V	-20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> = -20 V, V <sub>GS</sub> = 0V			-1.0	μA
		V <sub>Ds</sub> = -20 V, V <sub>GS</sub> = 0V, T <sub>J</sub> =70°C			-25	
Gate-source leadage	I <sub>GSS</sub>	V <sub>GS</sub> = ±12V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-0.40	-0.55	-0.95	V
Static drain-source on- resistance	R <sub>D(on)</sub>	I <sub>D</sub> = -3.7A, V <sub>GS</sub> = -4.5V		0.050	0.065	Ω
		I <sub>D</sub> = -3.1A, V <sub>GS</sub> = -2.5V		0.080	0.135	
Forward Transconductance	g <sub>f</sub>	V <sub>Ds</sub> = -10 V, I <sub>D</sub> = -3.7 A	6.0			S
Input capacitance	C <sub>iss</sub>	V <sub>Ds</sub> = -10 V,		633		pF
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V,		145		
Reverse transfer capacitance	C <sub>rss</sub>	f= 1MHz		110		
Total Gate Charge	Q <sub>g</sub>			8.0	12	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>Ds</sub> = -10V ,V <sub>GS</sub> = -5.0 V , I <sub>D</sub> = -3.7 A		1.2	1.8	
Gate-Drain Charge	Q <sub>gd</sub>			2.8	4.2	
Turn-on delay time	t <sub>d(on)</sub>			350		ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -10 V,		48		
Turn-off delay time	t <sub>d(off)</sub>			588		
Fall time	t <sub>f</sub>			381		
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> =25°C, I <sub>F</sub> = -1.0 A,		29	43	ns
Reverse recovery charge	Q <sub>rr</sub>	di / dt = -100 A/ μ s *2		11	17	nC
Continuous source current	I <sub>s</sub>	MOSFET symbol showing the integral reverse p-n junction diode			-1.3	A
Pulsed source current *1	I <sub>SM</sub>				-22	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> =25°C,V <sub>GS</sub> = 0 V, I <sub>s</sub> = -1.0 A *2			-1.2	V

\*1 Repetitive rating;pulse width limited by max.junction temperature.

\* 2 Pulse width ≤ 400 μ s, Duty cycle ≤ 2%



### ■ Marking

Marking	1E **
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### ■ Typical Characteristics

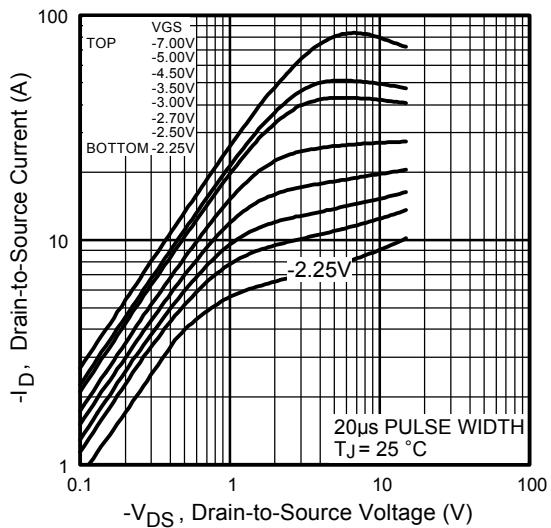


Fig 1. Typical Output Characteristics

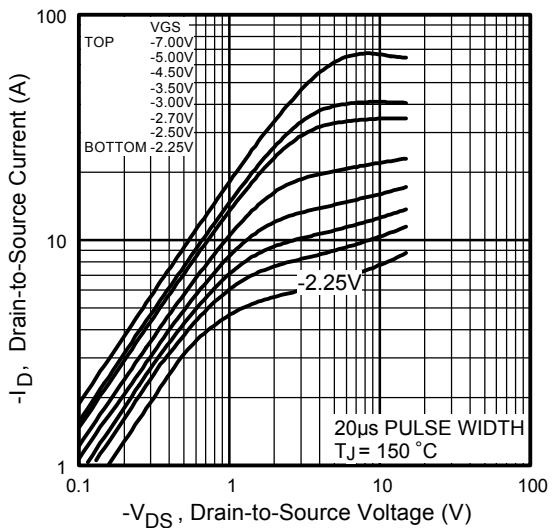


Fig 2. Typical Output Characteristics

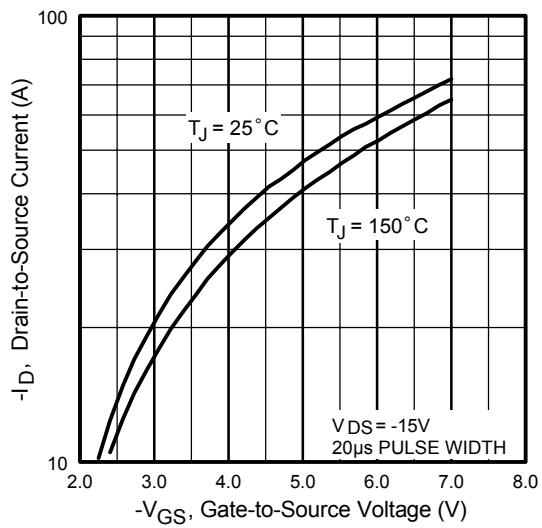


Fig 3. Typical Transfer Characteristics

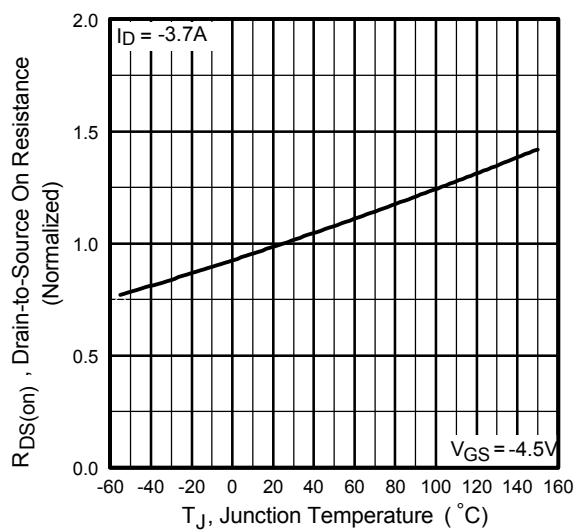


Fig 4. Normalized On-Resistance



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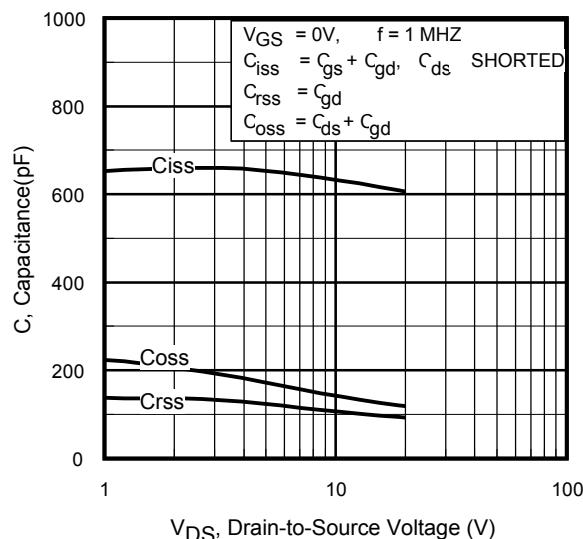
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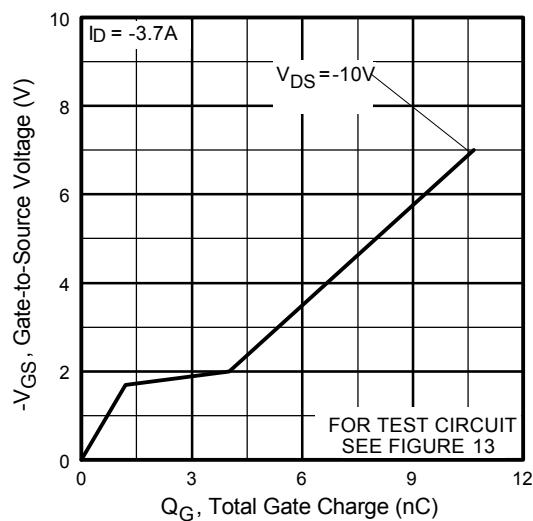
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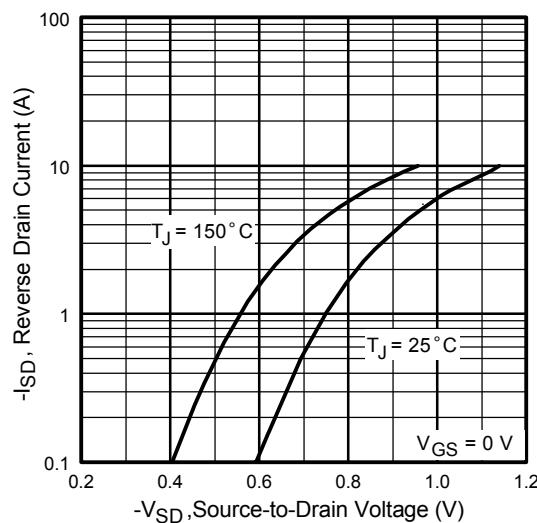
### ■ Typical Characteristics



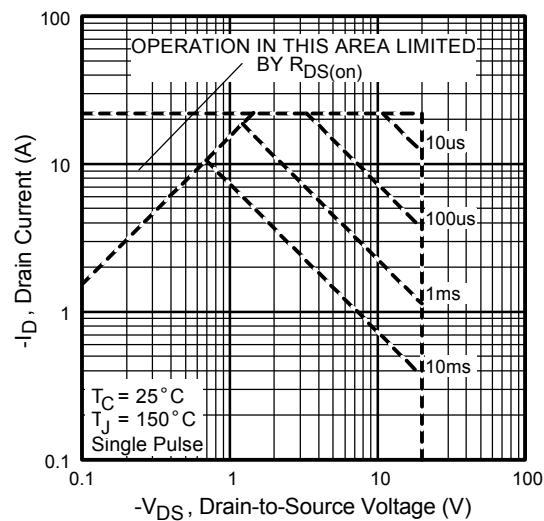
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



**Fig 8.** Maximum Safe Operating Area



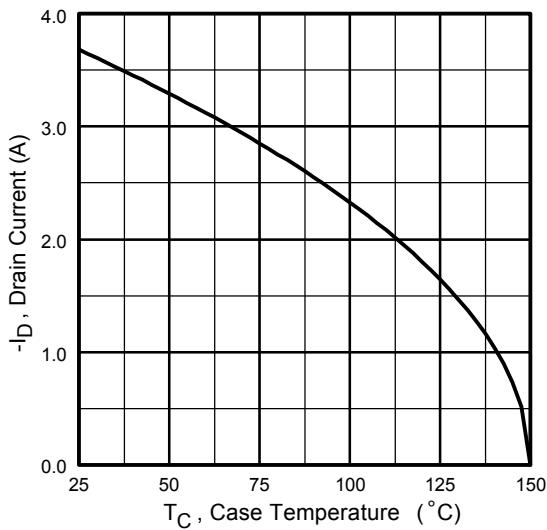
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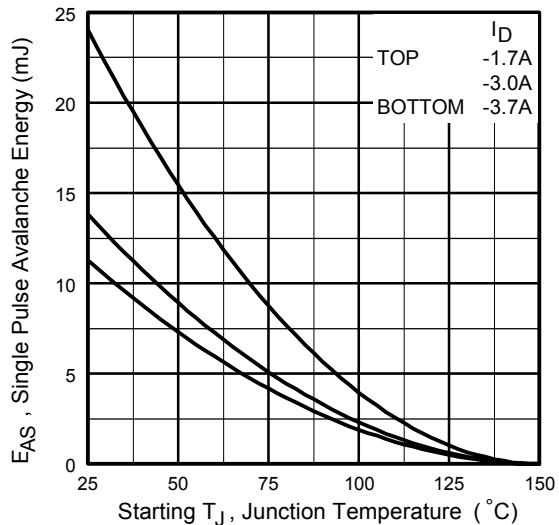
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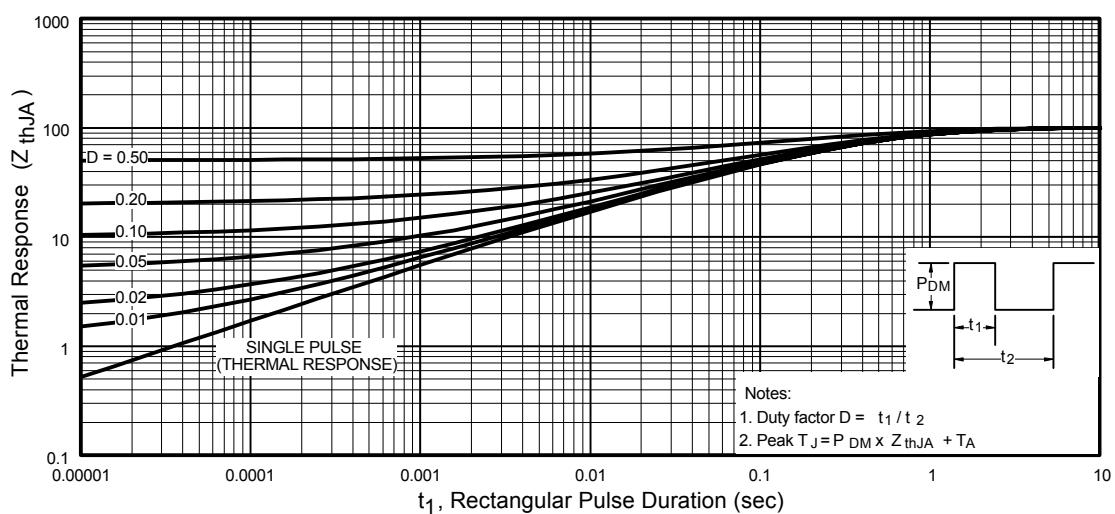
### ■ Typical Characteristics



**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10.** Maximum Avalanche Energy  
Vs. Drain Current



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



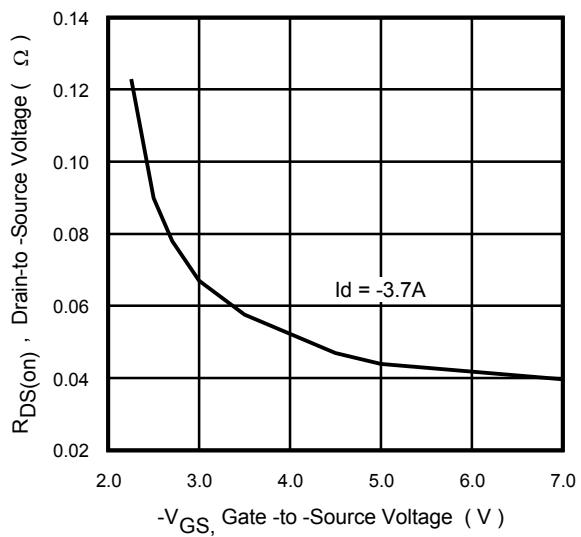
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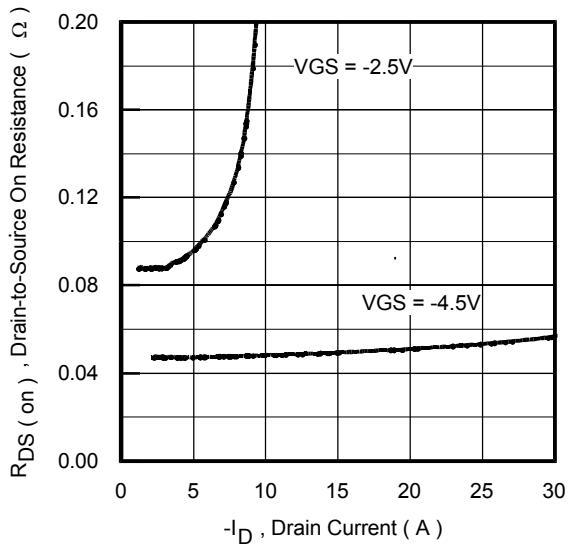
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### ■ Typical Characteristics



**Fig 12.** Typical On-Resistance Vs.  
Gate Voltage



**Fig 13.** Typical On-Resistance Vs.  
Drain Current